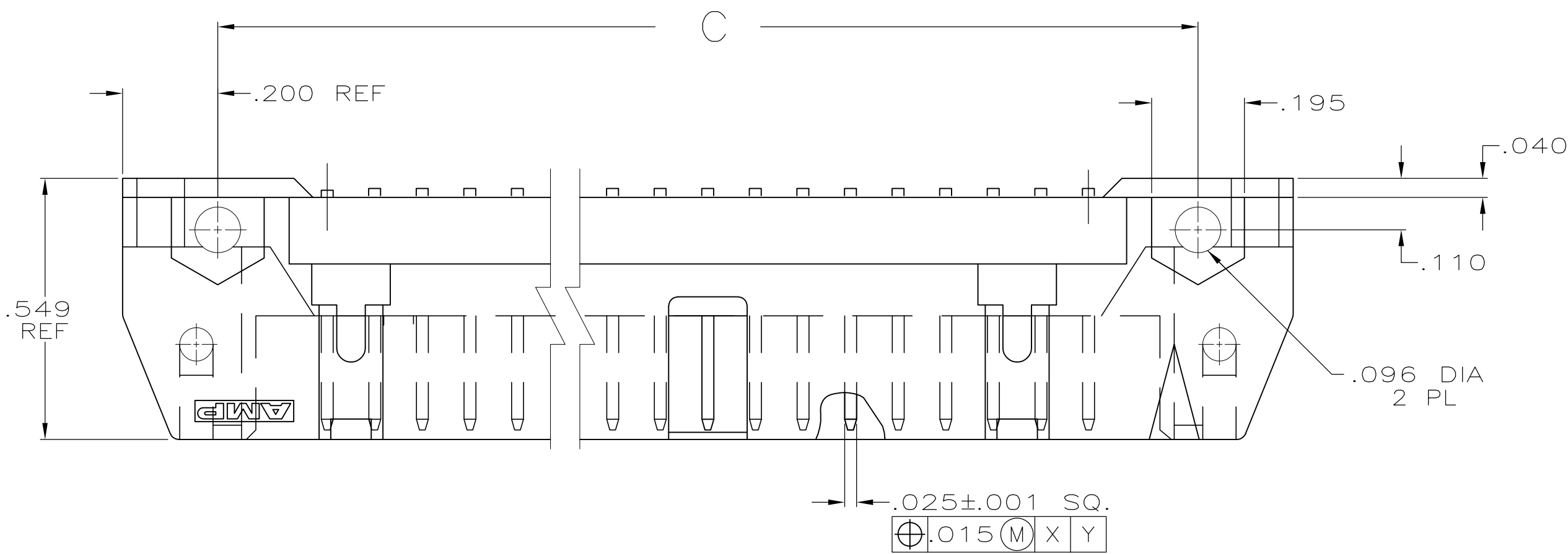
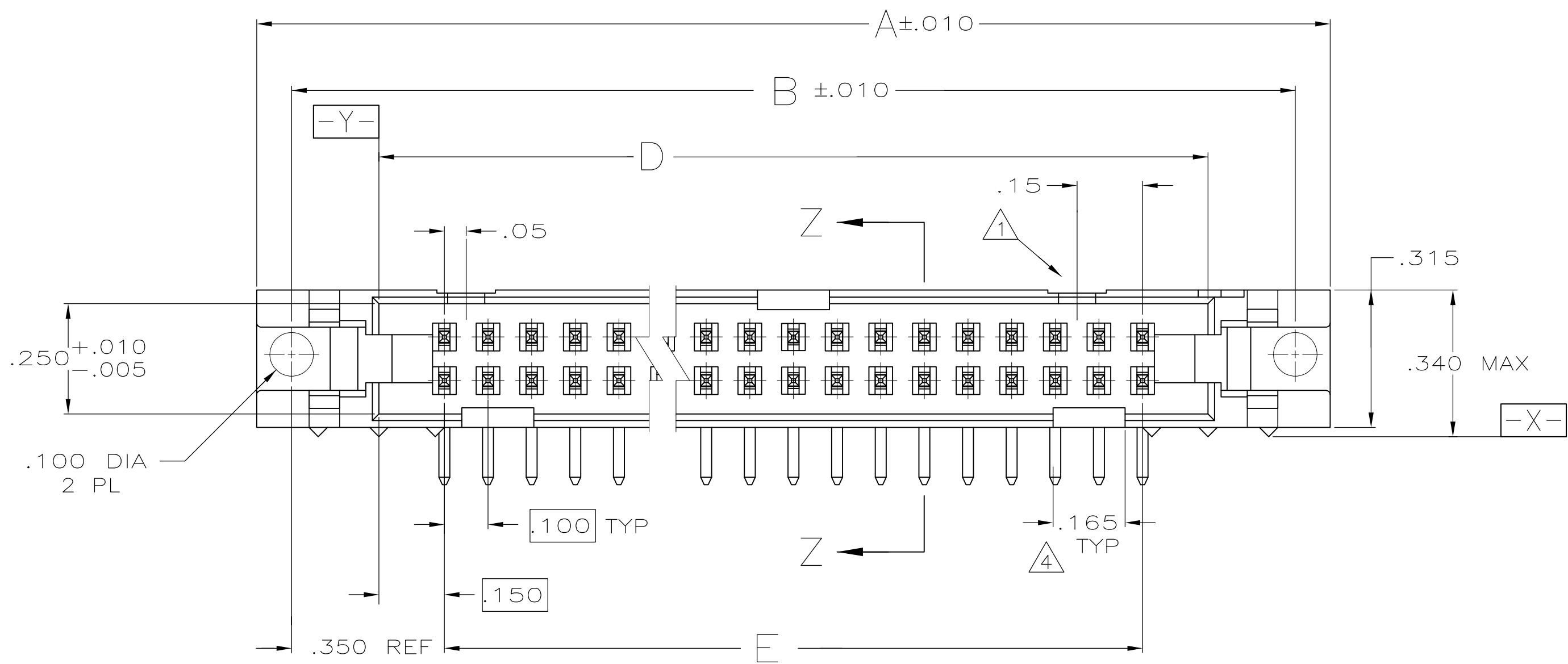


REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
J1		REVISED PER ECO-17-006767	02JUN2017	IT	WH

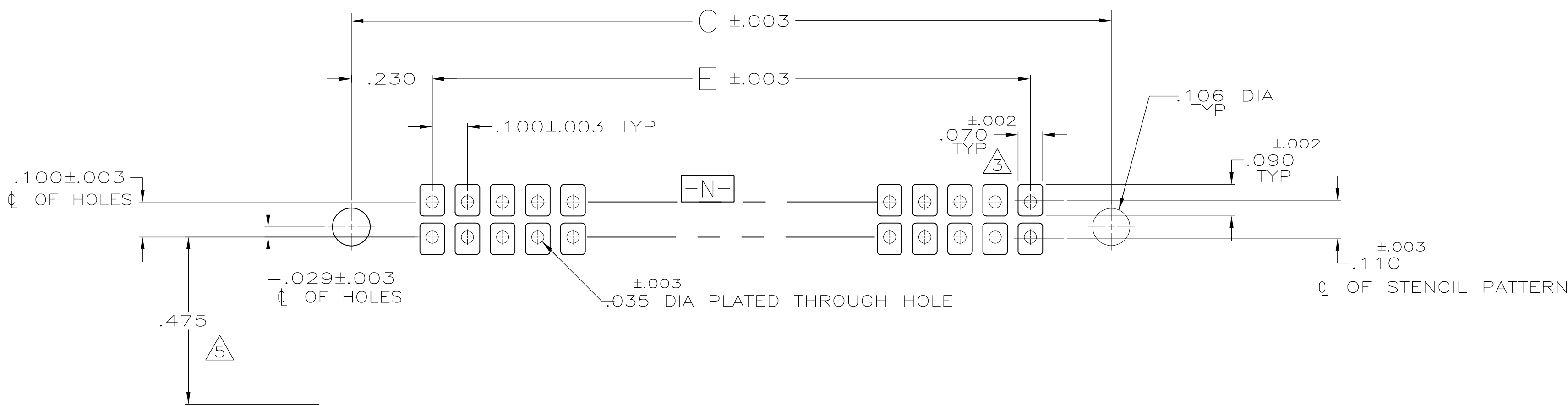
D



C



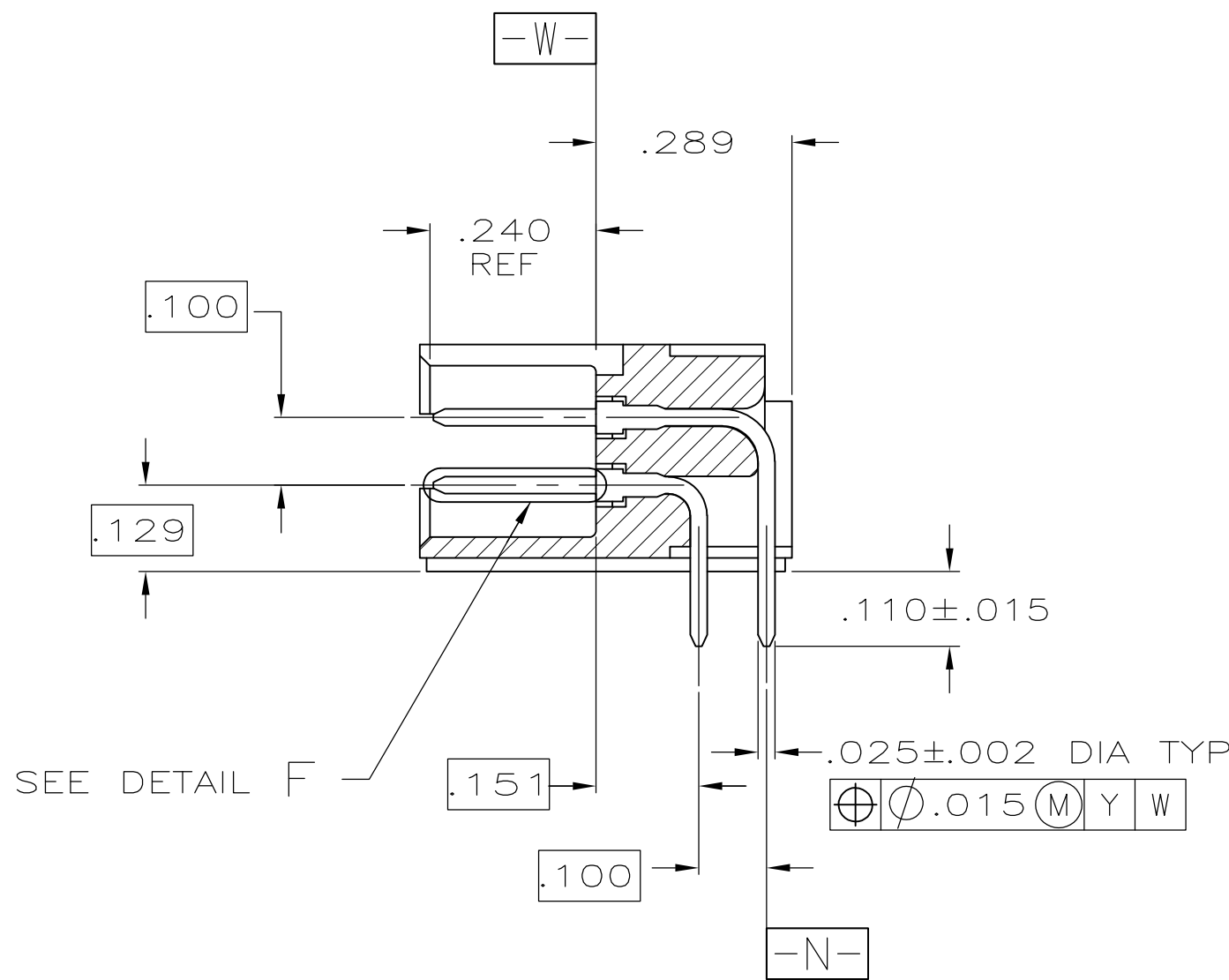
B



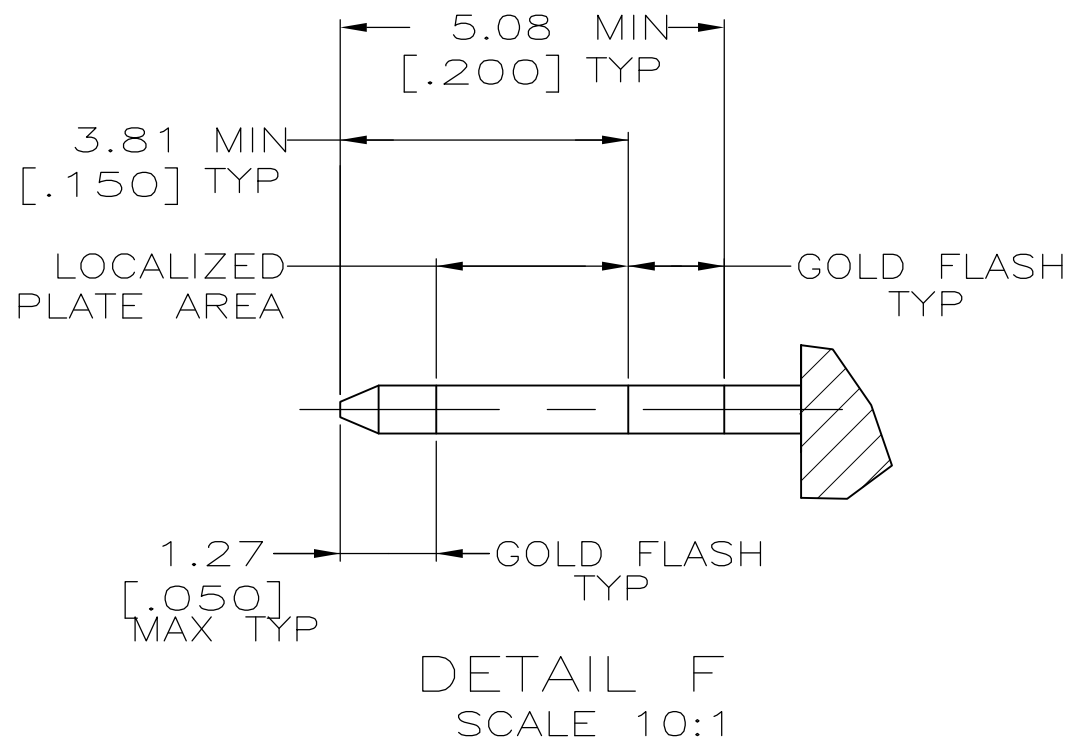
A

RECOMMENDED
P C BOARD MOUNTING DIMENSIONS

- 1 NO SNAP-IN POLARIZING FEATURE ON THIS END FOR 10 & 14 POS. HEADERS.
- 2 POST: GOLD FLASH OVER PALLADIUM-NICKEL PLATE, .000030 MIN TOTAL ON THE LOCALIZED PLATE AREA, .000100 MIN TIN-LEAD PLATE ON THE SOLDER-TAIL, .000050 MIN NICKEL UNDERPLATE ON THE ENTIRE POST.
-OR-
.000030 MIN GOLD PLATE ON THE LOCALIZED PLATE AREA, .000100 MIN TIN-LEAD PLATE ON THE SOLDER-TAIL, .000050 MIN NICKEL UNDERPLATE ON THE ENTIRE POST.
- 3 RECOMMENDED STENCIL THICKNESS EQUALS .010
- 4 FOR 10 POS.HEADER ONLY, ONE SLOT LOCATED AS SHOWN.
- 5 MAXIMUM DISTANCE FROM EDGE OF PC BOARD FOR DAISY CHAIN APPLICATIONS
- 6 OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI



SECTION Z-Z



△	OBSELETE	2.100	2.400	2.560	2.80	2.96	44	1-111105-3-
	OBSELETE	3.100	3.400	3.560	3.80	3.96	64	1-111105-2-
	OBSELETE	2.900	3.200	3.360	3.60	3.76	60	1-111105-1-
	OBSELETE	2.400	2.700	2.860	3.10	3.26	50	1-111105-0-
△	SUPERCEDED	1.900	2.200	2.360	2.60	2.76	40	-111105-9-
△	SUPERCEDED	1.600	1.900	2.060	2.30	2.46	34	-111105-8-
△	SUPERCEDED	1.400	1.700	1.860	2.10	2.26	30	-111105-7-
	OBSELETE	1.200	1.500	1.660	1.90	2.06	26	-111105-6-
△	SUPERCEDED	1.100	1.400	1.560	1.80	1.96	24	-111105-5-
	OBSELETE	.900	1.200	1.360	1.60	1.76	20	-111105-4-
△	SUPERCEDED	.700	1.000	1.160	1.40	1.56	16	-111105-3-
△	SUPERCEDED	.600	.900	1.060	1.30	1.46	14	-111105-2-
	OBSELETE	.400	.700	.860	1.10	1.26	10	-111105-1-
		E	D	C	B	A	NO. OF POSN	PART NUMBER